



Material Content Data Sheet



Halogen-Free

Sales Product Name	BTS7006-1EPZ	Issued	27. April 2022
MA#	MA005714250		
Package	PG-TSDSO-14-22	Weight*	65.10 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.001	1.54	1.54	15376	15376
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		145	
	non noble metal	zinc	7440-66-6	0.038	0.06		579	
	non noble metal	iron	7439-89-6	0.754	1.16		11583	
	non noble metal	copper	7440-50-8	30.617	47.04	48.27	470314	482621
wire	non noble metal	copper	7440-50-8	0.676	1.04	1.04	10389	10389
encapsulation	organic material	carbon black	1333-86-4	0.088	0.13		1345	
	plastics	epoxy resin	-	3.416	5.25		52468	
	inorganic material	silicondioxide	60676-86-0	25.690	39.46	44.84	394631	448444
leadfinish	non noble metal	tin	7440-31-5	1.642	2.52	2.52	25217	25217
plating	noble metal	silver	7440-22-4	0.816	1.25	1.25	12536	12536
glue	plastics	epoxy resin	-	0.062	0.09		948	
	noble metal	silver	7440-22-4	0.291	0.45	0.54	4469	5417
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com